

SPECIFICATION

产品规格书

REFOND P/N 产品型号

RF-W1SA35WS-CW1-40

R&D 研发

Mass Product 量产供货



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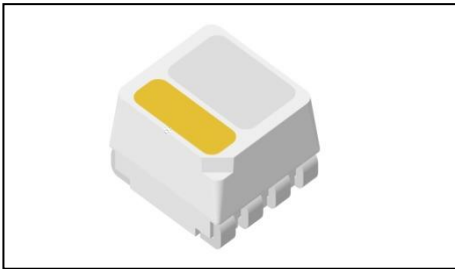


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1. Description 产品介绍

1.1 General Description 产品描述



is a special package type that uses the total 4 chips (R/G/B +W). The product size: 3.5mmX3.7mmX2.6mm.

它是一个特别的 4 合 1 封装方式，采用红绿蓝三色和白色共 4 晶片封装在一起，产品尺寸 3.5mmX3.7mmX2.6mm。

1.2 Features 产品特征

Extremely wide viewing angle. 发光角度大

High luminous Intensity, Low power dissipation, Good reliability and Long life.

光强高、功耗低、可靠性好、寿命长

Water-resistant (IPX6). 防水等级(IPX6)

Moisture sensitivity level: 5a. 潮湿敏感等级:5a

RoHS compliant. 满足RoHS要求

Matte surface. 哑光表面

Pb-free reflow soldering application. 无铅回流焊

1.3 Application 产品应用

Outdoor full-color video screen. 户外全彩显示屏

Indoor and outdoor decorative lighting. 室内外装饰照明

Amusement. 娱乐产品

General use. 其他应用





1.5 Product Parameters 产品参数

Table 1-1 Electrical / Optical Characteristics at Ts=25°C 电性与光学特性

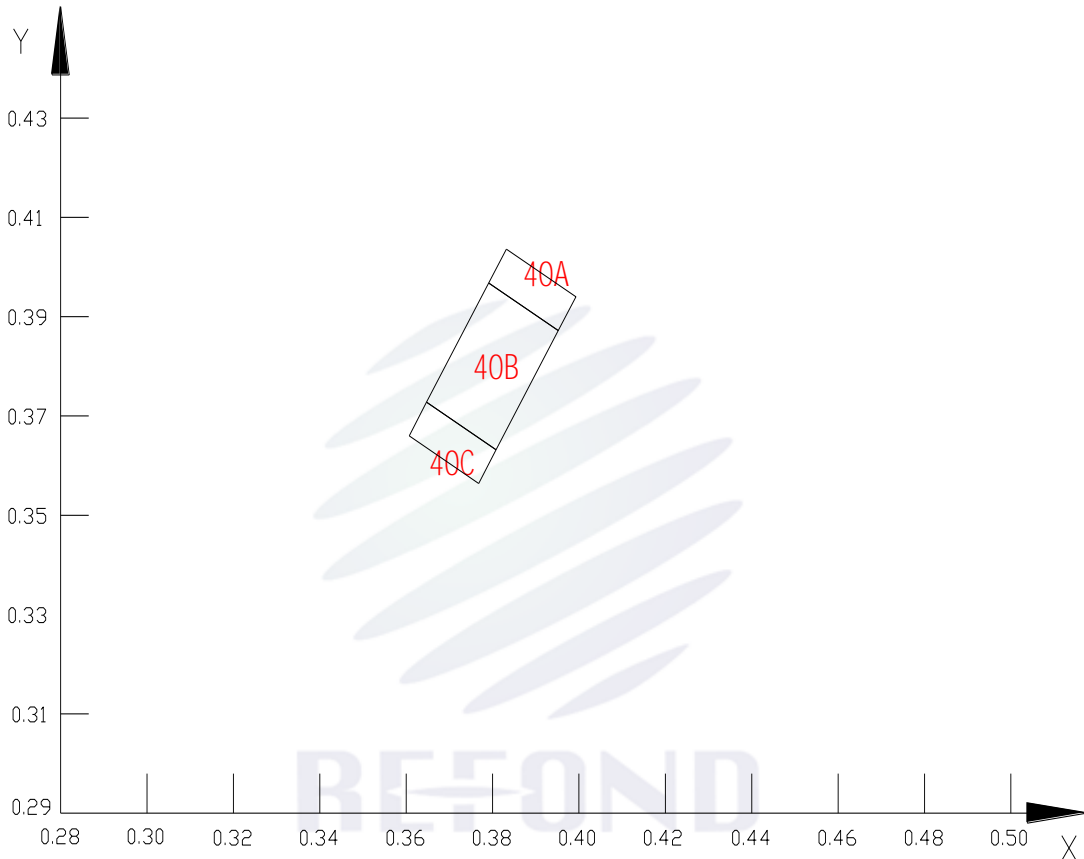
Item 项目	Symbol 符号	Test Condition 测试条件	Value				Unit 单位
			R	G	B	W	
Reverse Current (漏电流)	I_R	$V_R=5V$	6	6	6	6	
Forward Voltage (正向电压)	$V_{F\ min}$	R $I_F = 20mA$ G $I_F = 20mA$ B $I_F = 20mA$ W $I_F = 20mA$	1.7	2.7	2.7	2.7	V
	$V_{F\ max}$		2.4	3.4	3.4	3.4	V
Dominant Wavelength 主波长	λ_D		617~ 628	520~545	460~475	/	nm
			5nm per Bin	4nm per Bin	4nm per Bin		
Spectrum Radiation Bandwidth 半波宽			24	38	30	/	nm
Luminous Intensity 光强	$I_{V(min)}$		550	1450	320	1600	mcd
	$I_{V(avg)}$		825	2180	485	2400	mcd
	$I_{V(max)}$		1240	3250	720	3600	mcd
	BIN Range		1:1.4	1:1.4	1:1.4	1:1.4	
Viewing Angle (发光角度)			deg	110			

Table 1-2 Absolute Maximum Ratings at Ts=25°C 最大额定参数

Parameter (参数)	Symbol (符号)	Absolute Maximum Ratings (最大额定参数)				Unit 单位
		R	G	B	W	
Forward Current (正向电流)	I_F	25	20	20	20	mA
Reverse Voltage (反向电压)	V_R	5	5	5	5	V
Operating Temperature (工作温度)	T_{OPR}	-30 ~ +70				
Storage Temperature (储存温度)	T_{STQ}	-40 ~ +100				
Power Dissipation (功率)	P_D	60	68	68	68	mW
Total Junction Temperature (结温)	T_J	115	115	115	115	
Electrostatic Discharge (HBM) (静电)	E_{SD}	1000V				

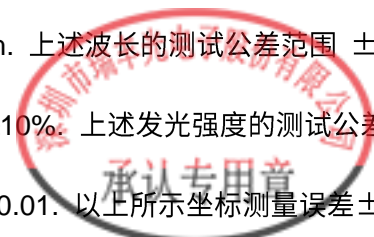
Table 1-3 The C.I.E Color coordinates CIE色坐标点

BIN	X1	Y1	X2	Y2	X3	Y3	X4	Y4
40A	0.3791	0.3968	0.3832	0.4036	0.3993		0.3952	0.3872
40B	0.3647	0.3728	0.3791	0.3968	0.3952	0.3872	0.3808	0.3632
40C	0.3607	0.366	0.3647	0.3728	0.3808	0.3632	0.3768	0.3564



Notes 备注:

1. The above forward voltage measurement allowance tolerance is $\pm 0.1V$. 上述电压的测试公差范围 $\pm 0.1V$.
2. The above Tolerance of measurement of dominant wavelength $\pm 1nm$. 上述波长的测试公差范围 $\pm 1nm$.
3. The above luminous intensity measurement allowance tolerance $\pm 10\%$. 上述发光强度的测试公差范围 $\pm 10\%$
4. The above color coordinates measurement allowance tolerance is ± 0.01 . 以上所示坐标测量误差 ± 0.01 .



5. Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product. 使用功率不能超过规定的最大额定值。
6. All measurements were made under the standardized environment of Refond. 所有测试都是基于瑞丰现有的标准测试平台。
7. Luminous intensity range is for reference only,specific parameters please refer to the label. 发光强度范围仅供参考,请以实物标签为准。

1.6 Typical optical characteristics curves 典型光学特性曲线

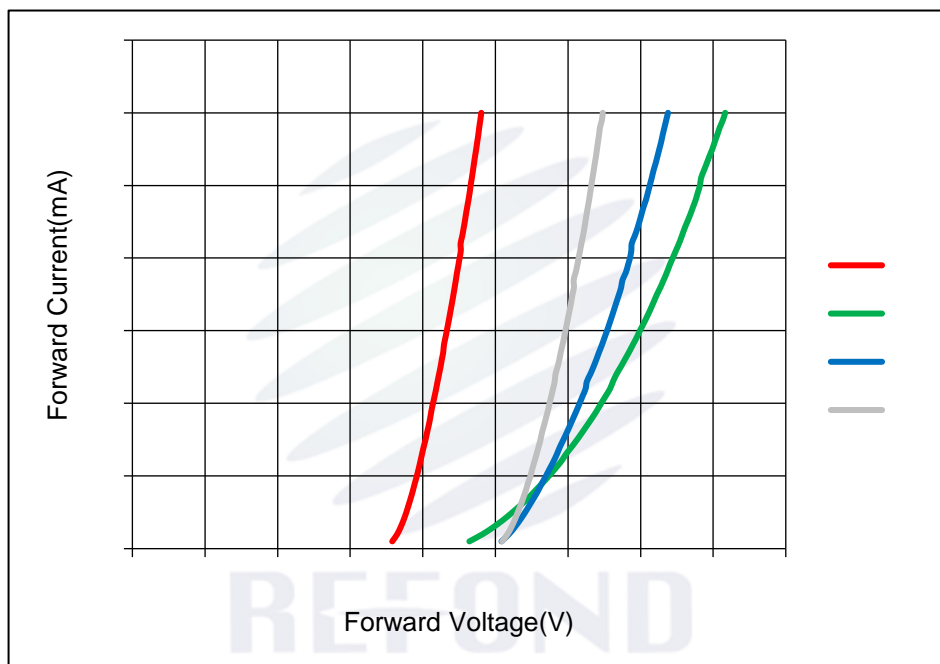


Fig 1-7 Forward Voltage Vs. Forward Current 伏安特性曲线



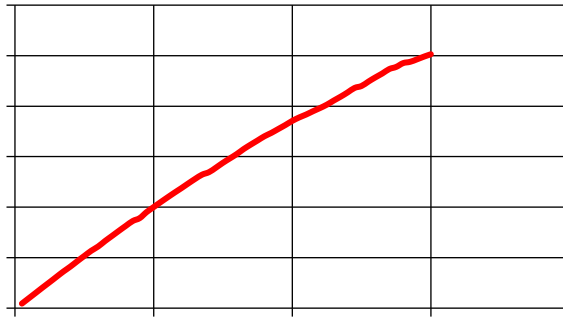


Fig 1-8 Forward Current Vs. Relative Intensity 正向电流与相对光强特性曲线

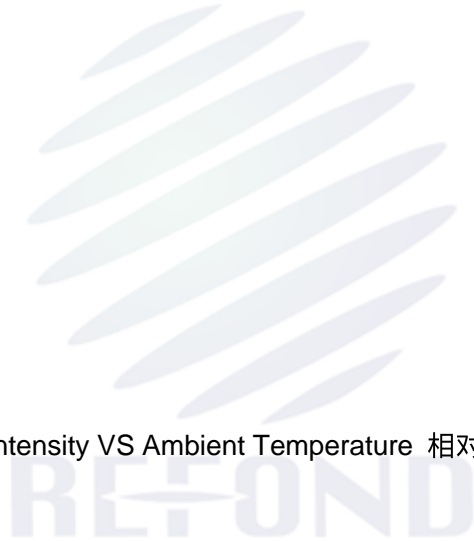


Fig 1-9 Luminous Intensity VS Ambient Temperature 相对光强与环境温度曲线

Fig 1-10 Solder Temperature Vs Forward Current 管脚温度与正向电流特性曲线

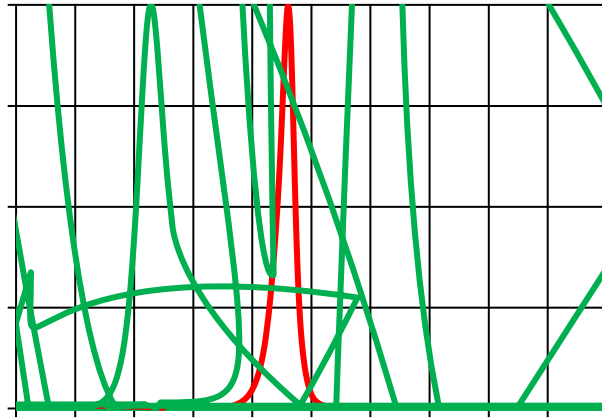


Fig 1-11 Spectrum Distribution光谱分布特性曲线



Fig 1-12 Radiation diagram 辐射特性曲线

2. Packaging 产品包装

2.1 Packaging Specification 包装规格

Package:4000pcs/reel.包装每卷 4000pcs。

2.1.1 Carrier Tape Dimension 载带尺寸

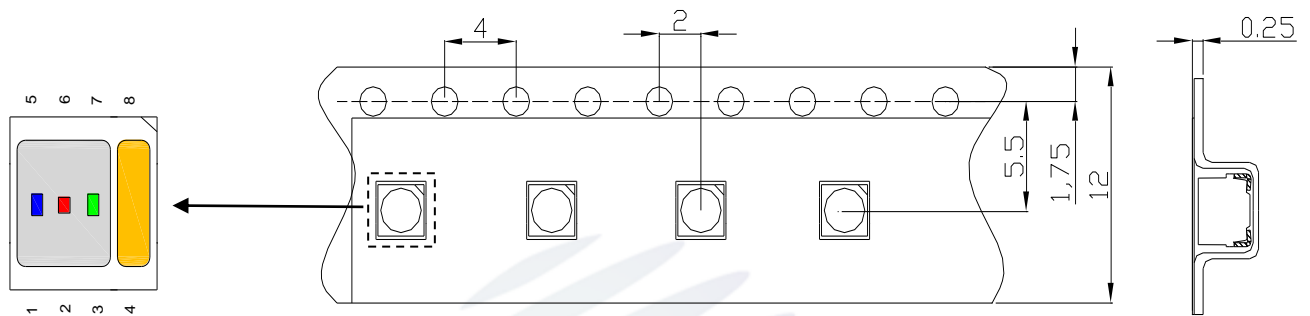


Fig.2-1 Carrier Tape Dimension 载带尺寸

2.1.2 Reel Dimension 卷盘尺寸

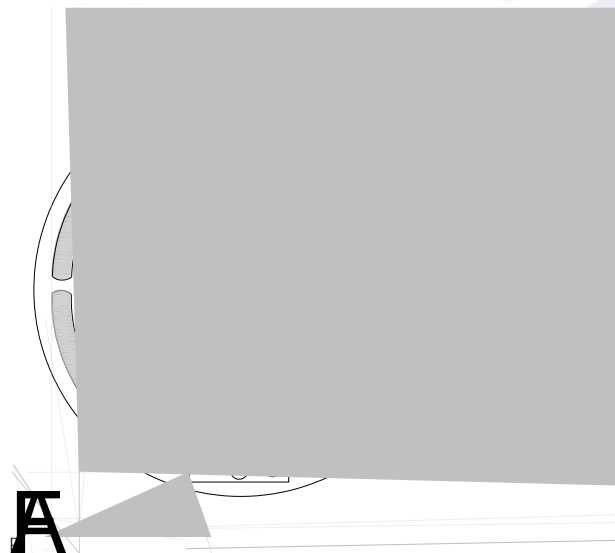


Fig.2-2 Reel 卷盘

Table 2-1 Dimension 描述

A	400±2mm
B	100.0±0.4mm
C	14.3±0.3mm
D	2.6±0.2mm
E	16.4±0.3mm
F	12.7 + 0.8/-0.3 mm
T	1.9±0.2mm

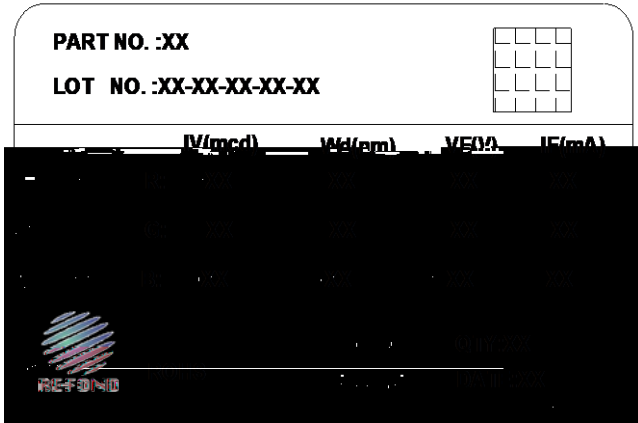
Notes 备注:

The tolerances unless mentioned ±0.1mm. Unit : mm 注: 未注公差为±0.1毫米, 尺寸单位: 毫米。



2.1.3 Label Form Specification 标签规格

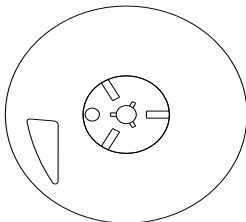
Table 2-2 Description 描述



PART NO.	Part Number 品名
LOT NO.	Lot Number + Packing Machine No. + Serial Number +BIN No. + Quantity (K) 批次号 + 包装机台号+流水号+BIN 号+数量 (K)
IV	Llight intensity 光强
VF	Forward Voltage 正向电压
Wd	Wavelength 波长代码
IF	Forward current 正向电流
QTY	Packing Quantity 数量
DATE	Made Date 生产日期

Fig 2-3 Label 标签

2.2 Moisture Resistant Packing 防潮包装



REFOND

Fig.2-4 Pack



2.3 Cardboard Box 包装纸箱

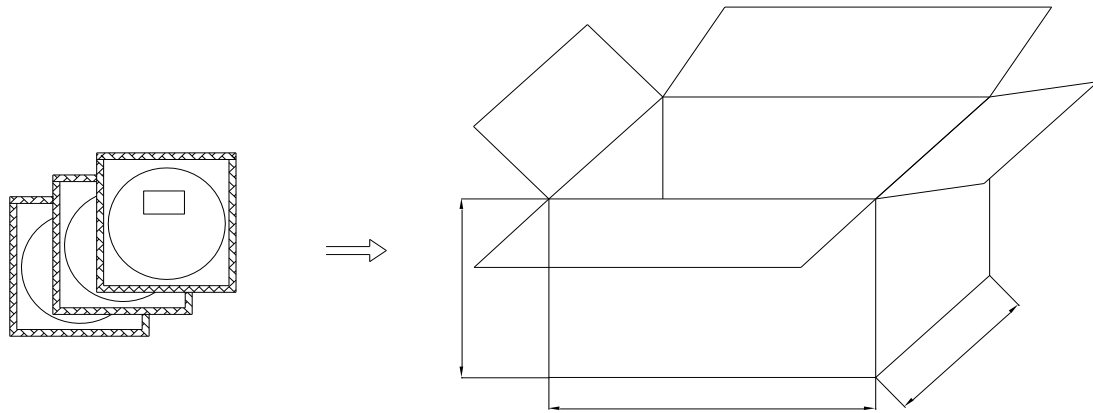
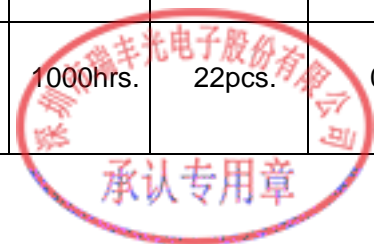


Fig.2-5 Box

2.4 Reliability Test Items And Conditions 信赖性测试项目及条件

Table 2-3 Reliability Condition 可靠性条件

Test Items 项目	Ref.Standard 参考标准	Test Condition 测试条件	Time 时间	Quantity 数量	Ac/Re 接收/拒收
Resistance to Soldering Heat 耐焊接热	JESD22-B106	Temp:260°Cmax T=10 sec	3times	22pcs.	0/1
Thermal Shock 冷热冲击	JEITAED-4701 300 307	-40°C 15min 10s 100°C 15min	500cycle	22pcs.	0/1
Moisture Resistance 防潮性	IPC/JEDEC J-STD-020D.1	1. Moisture Absorption Ta=85°C/ RH=85%/12HR 2. Tsol=260°C, T=10s Reflow Soldering	3times	22pcs.	0/1
High Temperature Storage 高温保存	JEITAED-4701 200 201	Temp:100°C	1000hrs.	22pcs.	0/1



Low Temperature Storage 低温保存	JEITA ED-4701 200 202	Temp:-40°C	1000hrs.	22pcs.	0/1
Room Temperature Operating Life 常温寿命测试	JESD22-A108	T _A =25°C I _F =20mA	1000hrs.	22pcs.	0/1
High Temperature High Humidity Life Test 高温高湿寿命测试	JESD22-A101	85°C/ 85%RH I _F =10mA	500hrs.	22pcs.	0/1
Temperature Humidity Storage 高温高湿储存	JEITA ED-4701 100 103	T _A =85°C R _H =85%	1000hrs.	22pcs.	0/1
Low Temperature Life Test 低温寿命	JESD22-A108D	T _A =-40°C, I _F =20mA	1000hrs.	22pcs.	0/1

2.5 Criteria For Judging Damage 失效判定标准

Table 2-4 Criteria 标准

Test Items 项目	Symbol 符号	Test Condition 测试条件	Criteria For Judgement 判定标准
Forward Voltage 正向电压	V _F	I _F =20mA	Initial Data ±10% 初始值 ±10%
Reverse Current 反向电流	I _R	V _R = 5V	I _R
Luminous Intensity 光强	I		

Notes 备注:

1. The Reliability tests are based on Refond existing test platform. 可靠性测试基于瑞丰现有的测试标准。
2. The above reliability tests is based on the verification of a single/strip LED of Refond's existing experimental platform, the reliability experiment was taken under good heat dissipation conditions. when customers applies the LED to the series and parallel circuit, should take consideration of all the factors such as the current, voltage distribution, heat dissipation and others. 以上可靠性测试是基于瑞丰现有实验平台单颗/条 LED 在良好散热条件验证下的结果。客户端将 LED 应用于串、并联线路时, 需自行评估电流、电压分配、散热等问题。

3. SMT Reflow Soldering Instructions SMT 回流焊说明

3.1 SMT Reflow Soldering Instructions SMT 回流焊说明

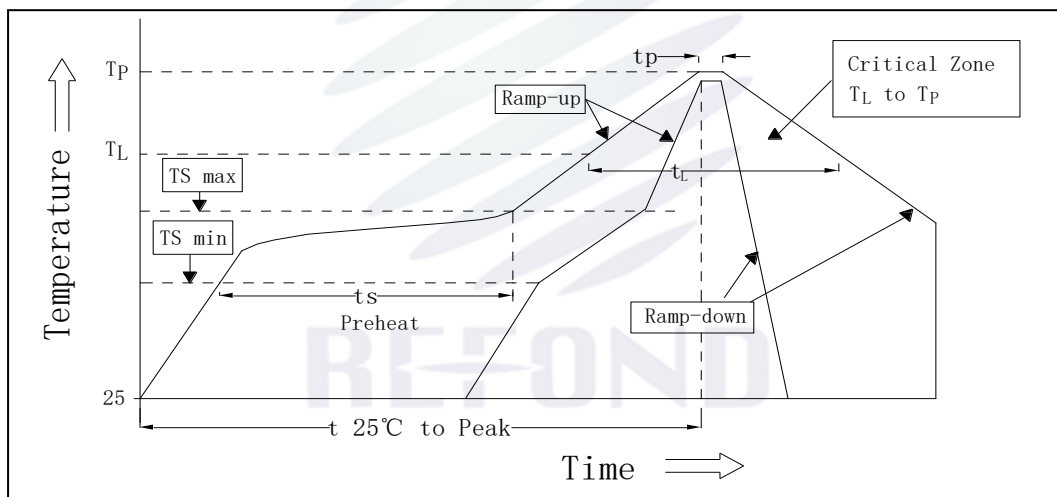


Fig.3-1 Profile





下降.

6. This product can differ in optical characteristics depending on the number of reflow cycles. In a single display, only LEDs with same number of reflow cycles should be used regardless of the application type, such as rental and/or permanent installations. 本产品的光学特性可能会因回流循环次数而异。在单个显示屏中，无论使用哪种目的类型（例如租赁或永久安装），都应仅使用回流次数LED。

7. This LED is designed to be reflow soldered on to a PCB. If dip soldered, cannot guarantee its reliability. 此LED设计为回流焊接到PCB上，如果采用浸焊，无法保证其可靠性。

3.1.1 Soldering Iron 烙铁焊接

(1) When hand soldering, keep the temperature of iron below less 300°C less than 3 seconds 当手工焊接时，烙铁的温度必须小于300°C，时间不可超过3秒。

(2) The hand solder should be done only one time. 手工焊接只可焊接一次。

3.1.2 Repairing 修补

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed in advance whether the characteristics of LEDs will or will not be damaged by repairing.

LED回流焊后不应该修复，当必须修复时，必须使用双头烙铁，而且事先应确认此种方式会不会损坏LED本身的特性。

3.1.3 Cleaning 清洗

The LEDs should not be cleaned with water, benzene, and/or thinner. Alcohol is recommended for cleaning. Before cleaning with other similar solvents, please make sure that the solvent used will not cause damage to the LED. Do not use ionic liquids containing "Cl" and "S" elements to clean the LED surface.

不应用水、苯和/或稀释剂清洗led。推荐使用酒精进行清洗，使用其它类似溶剂清洗前，请先确认使用的溶剂不会对LED造成损伤。不要使用含有“Cl”“S”元素的离子液体清洗LED表面。



4. Handling Precautions 产品使用注意事项

4.1 Handling Precautions

4.1.1 Storage 贮存

(1) Moisture proof and anti-electrostatic package with moisture absorbent material is used, Suggest storage time is less than 6 months.

本产品使用密封防潮抗静电袋包装,并附有干燥剂, 储存时间不要超过6个月.

(2)



4.1.2 Static Electricity 静电

Static electricity and surge voltage damage the LEDs. Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs do not light at the low current and even not light. All devices, equipment and machinery must be properly grounded. At the same time, it is also recommended that anti-electrostatic wrist bands, pads, uniforms, gloves or containers can be used as effective measures when dealing with the LEDs.

静电和电涌会导致产品特性发生改变,例如正向电压降低等,如果情况严重甚至会损毁产品。所以在使用时必须采取有效的防静电措施。所有相关的设备和机器都应该正确接地,同时必须采取其他防止静电和电涌的措施。使用防静电手环,防静电垫子,防静电工作服、工作鞋、手套,防静电容器,都是有效的防止静电和电涌的措施。

4.1.3 Reverse voltage protection 反压保护

In generally the reverse current of LED is very small, it can't effect using the component normally, but when it often suffered the reverse voltage which exceed the limits of the component than it will be damaged, the reverse current increases rapidly causing the string light display gray scale so when designing, please pay attention to control the reverse voltage we suggest the reverse voltage less than 5V.

通常 LED 的反向漏电流都会很小,不会影响正常使用。如果长期遭受超过其所能承受的反向电压冲击时,LED 会损伤,反向漏电流会迅速变大,引起显示屏零灰度下串光的发生。在设计中,要注意控制反向电压,建议加在 LED 上的反向电压值不超过 5V。

4.1.4 The safe temperature for LEDs working 温度保护

(1) Luminous Intensity deceased radically, if LEDs worked in hot environment for a long time, they will be disabled easily. When LEDs are working in surface temperature should be lower than 55 and the temperature should be lower than 75 .

LED 在高温条件下,衰减会加速,本身应力也会增大,若长期处于高温环境下,极容易出现失效。对于高密度排列使用的情况,建议在使用过程中灯面温度不超过 55°C,灯脚温度不超过 75°C。

(2) Proper thermal management is an important when designing products with LEDs. LED die temperature is affected by PCB thermal resistance and LED spacing on the board. Please design

products in a way that the LED die temperature does not exceed the maximum junction temperature (T_J).

在设计产品时，适当的热管理是很重要的。芯片温度受热阻和在板上的间距影响。请将产品设计成芯片温度不超过最高结温（ ）的方式。

(3) Drive current should be determined for the surrounding ambient temperature (T_A) to dissipate the heat from the product.

驱动电流应根据周围环境温度 (T_A) 来确定，以散发产品产生的热量。

4.1.5 Directions for Use 使用指南

(1) During designing a circuit, the current goes through each LED chip must not exceed the Absolute Max Rating current specified for each chip.

在打开包装之前，必须检查包装袋是否完好。在设计电路时，流经每个LED芯片的电流不得超过为每个芯片指定的绝对最大额定电流。

(2) It is recommended that each LED chip is driven by a constant current.

建议每个LED芯片均由恒定电流驱动。

(3) When having the two or more dices within this product at the same time, the total power dissipation for the LED package must be within the max value specified in this specification.

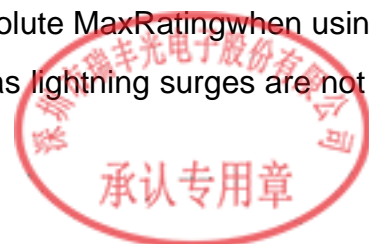
当需要同时应用两个或以上的灯珠时，LED封装的总功耗必须在此规格书指定的最大值以内。

(4) This product should be operated with forward current. Make sure the product is not subjected to reverse voltage. cially, DO NOT subject it to

continuous reverse voltage because it may cause damage to the LED chip. If the display will not be used for a long time, the main power should be switched off, Dehumidification is necessary before using the screen again.

本产品应在正向电流下使用。确保产品在不使用时不承受正向或反向电压，尤其不要对它施加连续的反向电压，因为它可能会损坏LED芯片。如果长时间不使用显示屏，则应关闭主电源，再次使用前应先进行除湿处理。

(5) Make sure that the reverse voltage will not exceed the Absolute Max Rating when using the LEDs with matrix drive. Ensure that excessive voltages such as lightning surges are not applied to the LEDs.



在矩阵驱动的 LED 上使用。请确保反向电压不超过绝对最大额定值。确保不要将过大的电压（例如雷电）施加到 LED 上。

(6) Aging is recommended in order to detect manufacturing and assembly defects. Particularly, make sure that excessive current and/or voltage is not applied to the LEDs. This aging should be conducted in environments where water condensation does not occur.

建议进行老化以检测制造和组装缺陷：特别要确保没有对 LED 施加过大的电流或电压。该老化应在不发生水凝结的环境中进行。

(7) when the LEDs are used in the following environments, incorporate sufficient measures into the display to prevent debris, water/moisture and gases that will adversely affect the product.

- where water vapor is abundant
- where water condensation is likely to occur
- where water is likely to splash onto the LEDs
- where frost is likely to form on the surface of the LEDs (e.g. freezer, ice skating rink, etc.)
- where dust, dirt, debris, loose metallic materials and/or gases that will adversely affect the product are present

在以下环境中使用LED时，请在显示屏中采取足够的措施，以防止会对产品产生不利影响的碎屑、水分和气体。

- 水蒸气丰富的地方
- 可能发生水凝结的地方
- 水很可能溅到LED上的地方
- LED的表面可能会结霜的地方（例如冰箱，溜冰场等）
- 存在对产品有不利影响的灰尘，污垢，碎屑，松散的金属材料或气体

(8) In areas where hydrogen sulfide, which is a sulfide-based gas, is present (e.g. hot springs and volcanic areas), and where salt is abundant (e.g. coastal areas), the life may be shortened.

而在存在硫化氢（一种基于硫化合物的气体）的地区（例如温泉和火山区）以及盐分丰富的地区（例如沿海地区），寿命可能会缩短。

(9) 100% wattage for the LEDs may have absorbed moisture. Before normal use of this display, operate the display at approximately 20% wattage for an initial time period.



显示屏安装后首次通电时，因为LED可能吸收了水分，不应以100%的功率供电。在正常使用此显示屏前，请在初始时间段内以约20%的功率运行。

(10) If the display units will be rented, those units should be selected carefully to ensure that the display as a whole will appear the same color and brightness.

如果要租借展示，则应仔细选择箱体

(11) If the display modules are loaded onto and/or transported by ship, the moisture environment on the vessel can cause condensation; the display units should be packaged to prevent moisture absorption.

如果显示模块装在船上或由船运输，则船上潮湿的环境可能会导致冷凝；展
收水分。

(12) If a display that has been, or is being, used is relocated, it is possible that degradation of the LED has occurred. When transporting this display, provide sufficient protection for the LEDs in addition to the moisture-proof packaging for the display. When this display is reinstalled, ensure to follow the installation instructions for environments and use.

如果重新搬运已经使用或正在使用的显示屏，则可能发生了LED退化。运输此显示屏时，除了要为显示屏提供防潮包装外，还要为LED提供足够的保护。重新安装此显示屏后，请确保遵循有关环境和使用的安装说明。

4.1.6 Others 其它事项

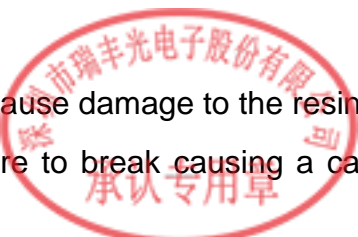
(1) Do not directly touch or handle the epoxy surface. It may damage the internal circuitry. Handle the component along the side surfaces by using forceps or appropriate tools.

请勿直接触摸或操作环氧树脂表面，这可能会损坏内部的电路，拿取时用镊子或合适的工具夹在元件的侧面。

(2) Do not handle the LEDs with bare hands as it will contaminate the LED surface and may affect the optical characteristics: it might cause the LED to be deformed and/or the wire to break, which will cause the LED not to illuminate. The lead could also cause an injury.

请勿裸手操作 LED，因为这会污染 LED 表面并可能影响其光学特性。它可能会导致 LED 变形或线材断裂，从而导致 LED 不发光。也可能造成线路受损。

(3) Do not stack assembled PCBs together. Otherwise, it may cause damage to the resin (e.g. cut, scratch, chip, crack, delamination and deformation) and the wire to break causing a catastrophic failure (i.e. the LED not to illuminate).



不要将组装好的 PCB 堆叠在一起。否则，可能会损坏树脂（例如，割伤，刮伤，碎屑，破裂，分层和变形），并且线材会断裂而导致灾难性故障（即 LED 不亮）。

(4) Other precautions, please refer to our "Ruifeng Photoelectric Full color SMD LED device User Manual".

其他注意事项,请参考我司《瑞丰光电全彩 SMD LED

4.1.7 Declare 申明

(1) This specification is written both in English and in Chinese and the latter is formal.

此规格书以中英文方式书写，若有冲突以中文版本为准。

(2) Both the customers and Refond will agree on official sp





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Declare 申明

This specification is written both in English and in Chinese and the latter is formal.

产品规格书以中英文方式书写，~~以版本为准~~ 后者为正式

